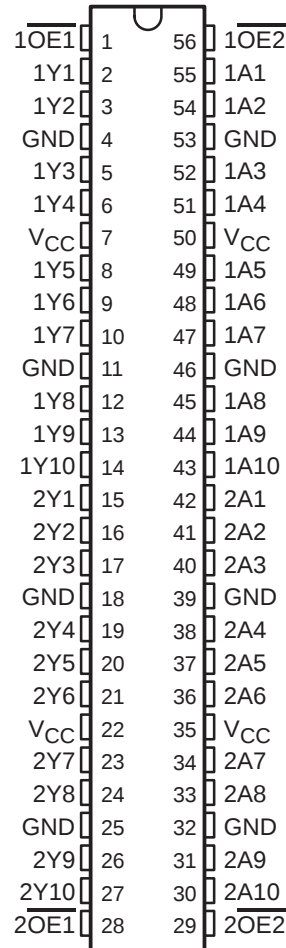


# SN54ALVTH162827, SN74ALVTH162827 2.5-V/3.3-V 20-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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- State-of-the-Art Advanced BiCMOS Technology (ABT) *Widebus*™ Design for 2.5-V and 3.3-V Operation and Low Static Power Dissipation
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 2.3-V to 3.6-V  $V_{CC}$ )
- Typical  $V_{OLP}$  (Output Ground Bounce)  $<0.8$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Power Off Disables Outputs, Permitting Live Insertion
- High-Impedance State During Power Up and Power Down Prevents Driver Conflict
- Uses Bus Hold on Data Inputs in Place of External Pullup/Pulldown Resistors to Prevent the Bus From Floating
- Output Ports Have Equivalent 30- $\Omega$  Series Resistors, So No External Resistors Are Required
- Auto3-State Eliminates Bus Current Loading When Output Exceeds  $V_{CC} + 0.5$  V
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model; and Exceeds 1000 V Using Charged-Device Model, Robotic Method
- Flow-Through Architecture Facilitates Printed Circuit Board Layout
- Distributed  $V_{CC}$  and GND Pin Configuration Minimizes High-Speed Switching Noise
- Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV) Packages, and 380-mil Fine-Pitch Ceramic Flat (WD) Package

SN54ALVTH162827 . . . WD PACKAGE  
SN74ALVTH162827 . . . DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



NOTE: For order entry:

The DGG package is abbreviated to G, and  
the DGV package is abbreviated to V.

## description

The 'ALVTH162827 devices are 20-bit buffers/line drivers designed for 2.5-V or 3.3-V  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment.



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SN54ALVTH162827, SN74ALVTH162827  
 2.5-V/3.3-V 20-BIT BUFFERS/DRIVERS  
 WITH 3-STATE OUTPUTS

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description (continued)

The devices are composed of two 10-bit sections with separate output-enable signals. For either 10-bit buffer section, the two output-enable ( $\overline{1OE1}$  and  $\overline{1OE2}$ , or  $\overline{2OE1}$  and  $\overline{2OE2}$ ) inputs must be low for the corresponding Y outputs to be active. If either output-enable input is high, the outputs of that 10-bit buffer section are in the high-impedance state.

When  $V_{CC}$  is between 0 and 1.2 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.2 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

All outputs are designed to sink up to 12 mA, and include equivalent 30-Ω resistors to reduce overshoot and undershoot.

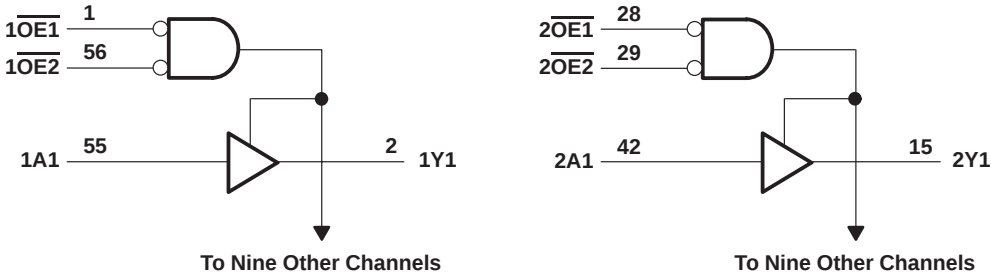
Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN54ALVTH162827 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALVTH162827 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE  
 (each 10-bit section)

| INPUTS           |                  |   | OUTPUT |
|------------------|------------------|---|--------|
| $\overline{OE1}$ | $\overline{OE2}$ | A | Y      |
| L                | L                | L | L      |
| L                | L                | H | H      |
| H                | X                | X | Z      |
| X                | H                | X | Z      |

logic diagram (positive logic)



**SN54ALVTH162827, SN74ALVTH162827**  
**2.5-V/3.3-V 20-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>**

|                                                                                                  |                 |
|--------------------------------------------------------------------------------------------------|-----------------|
| Supply voltage range, $V_{CC}$                                                                   | –0.5 V to 4.6 V |
| Input voltage range, $V_I$ (see Note 1)                                                          | –0.5 V to 7 V   |
| Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) | –0.5 V to 7 V   |
| Voltage range applied to any output in the high state, $V_O$ (see Note 1)                        | –0.5 V to 7 V   |
| Output current in the low state, $I_O$ : SN54ALVTH162827                                         | 96 mA           |
| SN74ALVTH162827                                                                                  | 128 mA          |
| Output current in the high state, $I_O$ : SN54ALVTH162827                                        | –48 mA          |
| SN74ALVTH162827                                                                                  | –64 mA          |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                                                      | –50 mA          |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )                                                     | –50 mA          |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): DGG package                               | 81°C/W          |
| DGV package                                                                                      | 86°C/W          |
| DL package                                                                                       | 74°C/W          |
| Storage temperature range, $T_{stg}$                                                             | –65°C to 150°C  |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51.

**recommended operating conditions,  $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$  (see Note 3)**

|                          |                                    | SN54ALVTH162827 |          |     | SN74ALVTH162827 |          |     | UNIT |
|--------------------------|------------------------------------|-----------------|----------|-----|-----------------|----------|-----|------|
|                          |                                    | MIN             | TYP      | MAX | MIN             | TYP      | MAX |      |
| $V_{CC}$                 | Supply voltage                     | 2.3             |          | 2.7 | 2.3             |          | 2.7 | V    |
| $V_{IH}$                 | High-level input voltage           | 1.7             |          |     | 1.7             |          |     | V    |
| $V_{IL}$                 | Low-level input voltage            |                 |          | 0.7 |                 |          | 0.7 | V    |
| $V_I$                    | Input voltage                      | 0               | $V_{CC}$ | 5.5 | 0               | $V_{CC}$ | 5.5 | V    |
| $I_{OH}$                 | High-level output current          |                 |          | –6  |                 |          | –8  | mA   |
| $I_{OL}$                 | Low-level output current           |                 |          | 8   |                 |          | 12  | mA   |
| $\Delta t/\Delta v$      | Input transition rise or fall rate | Outputs enabled |          | 10  |                 |          | 10  | ns/V |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate                 | 200             |          |     | 200             |          |     | μs/V |
| $T_A$                    | Operating free-air temperature     | –55             |          | 125 | –40             |          | 85  | °C   |

NOTE 3: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

**SN54ALVTH162827, SN74ALVTH162827**  
**2.5-V/3.3-V 20-BIT BUFFERS/DRIVERS**  
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**recommended operating conditions,  $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  (see Note 3)**

|                          |                                    |                 | SN54ALVTH162827 |          |     | SN74ALVTH162827 |          |     | UNIT            |
|--------------------------|------------------------------------|-----------------|-----------------|----------|-----|-----------------|----------|-----|-----------------|
|                          |                                    |                 | MIN             | TYP      | MAX | MIN             | TYP      | MAX |                 |
| $V_{CC}$                 | Supply voltage                     |                 | 3               |          | 3.6 | 3               |          | 3.6 | V               |
| $V_{IH}$                 | High-level input voltage           |                 | 2               |          |     | 2               |          |     | V               |
| $V_{IL}$                 | Low-level input voltage            |                 |                 |          | 0.8 |                 |          | 0.8 | V               |
| $V_I$                    | Input voltage                      |                 | 0               | $V_{CC}$ | 5.5 | 0               | $V_{CC}$ | 5.5 | V               |
| $I_{OH}$                 | High-level output current          |                 |                 |          | –8  |                 |          | –12 | mA              |
| $I_{OL}$                 | Low-level output current           |                 |                 |          | 8   |                 |          | 12  | mA              |
| $\Delta t/\Delta v$      | Input transition rise or fall rate | Outputs enabled |                 |          | 10  |                 |          | 10  | ns/V            |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate                 |                 | 200             |          |     | 200             |          |     | $\mu\text{s/V}$ |
| $T_A$                    | Operating free-air temperature     |                 | –55             |          | 125 | –40             |          | 85  | °C              |

NOTE 3: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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2.5-V/3.3-V 20-BIT BUFFERS/DRIVERS  
WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (unless otherwise noted)

| PARAMETER             |                | TEST CONDITIONS                                                                                                                         | SN54ALVTH162827 |      |           | SN74ALVTH162827 |      |           | UNIT          |
|-----------------------|----------------|-----------------------------------------------------------------------------------------------------------------------------------------|-----------------|------|-----------|-----------------|------|-----------|---------------|
|                       |                |                                                                                                                                         | MIN             | TYP† | MAX       | MIN             | TYP† | MAX       |               |
| $V_{IK}$              |                | $V_{CC} = 2.3 \text{ V}$ ,<br>$I_I = -18 \text{ mA}$                                                                                    |                 |      | -1.2      |                 |      | -1.2      | V             |
| $V_{OH}$              |                | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ ,<br>$I_{OH} = -100 \mu\text{A}$                                                             | $V_{CC}-0.2$    |      |           | $V_{CC}-0.2$    |      |           | V             |
|                       |                | $V_{CC} = 2.3 \text{ V}$ ,<br>$I_{OH} = -6 \text{ mA}$                                                                                  | 1.7             |      |           |                 |      |           |               |
|                       |                | $V_{CC} = 2.3 \text{ V}$ ,<br>$I_{OH} = -8 \text{ mA}$                                                                                  |                 |      |           | 1.7             |      |           |               |
| $V_{OL}$              |                | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ ,<br>$I_{OL} = 100 \mu\text{A}$                                                              |                 |      | 0.2       |                 |      | 0.2       | V             |
|                       |                | $V_{CC} = 2.3 \text{ V}$ ,<br>$I_{OL} = 8 \text{ mA}$                                                                                   |                 |      | 0.7       |                 |      |           |               |
|                       |                | $V_{CC} = 2.3 \text{ V}$ ,<br>$I_{OL} = 12 \text{ mA}$                                                                                  |                 |      |           |                 |      | 0.7       |               |
| $I_I$                 | Control inputs | $V_{CC} = 2.7 \text{ V}$ ,<br>$V_I = V_{CC} \text{ or GND}$                                                                             |                 |      | $\pm 1$   |                 |      | $\pm 1$   | $\mu\text{A}$ |
|                       |                | $V_{CC} = 0 \text{ or } 2.7 \text{ V}$ ,<br>$V_I = 5.5 \text{ V}$                                                                       |                 |      | 10        |                 |      | 10        |               |
|                       | Data inputs    | $V_{CC} = 2.7 \text{ V}$ ,<br>$V_I = 5.5 \text{ V}$                                                                                     |                 |      | 10        |                 |      | 10        |               |
|                       |                | $V_{CC} = 2.7 \text{ V}$ ,<br>$V_I = V_{CC}$                                                                                            |                 |      | 1         |                 |      | 1         |               |
|                       |                | $V_{CC} = 2.7 \text{ V}$ ,<br>$V_I = 0$                                                                                                 |                 |      | -5        |                 |      | -5        |               |
| $I_{off}$             |                | $V_{CC} = 0$ ,<br>$V_I \text{ or } V_O = 0 \text{ to } 4.5 \text{ V}$                                                                   |                 |      |           |                 |      | $\pm 100$ | $\mu\text{A}$ |
| $I_{BHL}^\ddagger$    |                | $V_{CC} = 2.3 \text{ V}$ ,<br>$V_I = 0.7 \text{ V}$                                                                                     |                 |      | 115       |                 |      | 115       | $\mu\text{A}$ |
| $I_{BHH}^\S$          |                | $V_{CC} = 2.3 \text{ V}$ ,<br>$V_I = 1.7 \text{ V}$                                                                                     |                 |      | -10       |                 |      | -10       | $\mu\text{A}$ |
| $I_{BHLO}^\P$         |                | $V_{CC} = 2.7 \text{ V}$ ,<br>$V_I = 0 \text{ to } V_{CC}$                                                                              | 300             |      |           | 300             |      |           | $\mu\text{A}$ |
| $I_{BHHO}^\#$         |                | $V_{CC} = 2.7 \text{ V}$ ,<br>$V_I = 0 \text{ to } V_{CC}$                                                                              | -300            |      |           | -300            |      |           | $\mu\text{A}$ |
| $I_{EX}^{  }$         |                | $V_{CC} = 2.3 \text{ V}$ ,<br>$V_O = 5.5 \text{ V}$                                                                                     |                 |      | 125       |                 |      | 125       | $\mu\text{A}$ |
| $I_{OZ(PU/PD)}^\star$ |                | $V_{CC} \leq 1.2 \text{ V}$ , $V_O = 0.5 \text{ V to } V_{CC}$ ,<br>$V_I = \text{GND or } V_{CC}$ , $\overline{OE} = \text{don't care}$ |                 |      | $\pm 100$ |                 |      | $\pm 100$ | $\mu\text{A}$ |
| $I_{OZH}$             |                | $V_{CC} = 2.7 \text{ V}$ ,<br>$V_O = 2.3 \text{ V}$ ,<br>$V_I = 0.7 \text{ V or } 1.7 \text{ V}$                                        |                 |      | 5         |                 |      | 5         | $\mu\text{A}$ |
| $I_{OZL}$             |                | $V_{CC} = 2.7 \text{ V}$ ,<br>$V_O = 0.5 \text{ V}$ ,<br>$V_I = 0.7 \text{ V or } 1.7 \text{ V}$                                        |                 |      | -5        |                 |      | -5        | $\mu\text{A}$ |
| $I_{CC}$              |                | $V_{CC} = 2.7 \text{ V}$ ,<br>$I_O = 0$ ,<br>$V_I = V_{CC} \text{ or GND}$                                                              |                 |      |           |                 |      |           | mA            |
|                       |                | Outputs high                                                                                                                            | 0.04            | 0.1  |           | 0.04            | 0.1  |           |               |
|                       |                | Outputs low                                                                                                                             | 2.3             | 5    |           | 2.3             | 5    |           |               |
|                       |                | Outputs disabled                                                                                                                        | 0.04            | 0.1  |           | 0.04            | 0.1  |           |               |
| $C_i$                 |                | $V_{CC} = 2.5 \text{ V}$ ,<br>$V_I = 2.5 \text{ V or } 0$                                                                               |                 |      | 3.5       |                 |      | 3.5       | pF            |
| $C_o$                 |                | $V_{CC} = 2.5 \text{ V}$ ,<br>$V_O = 2.5 \text{ V or } 0$                                                                               |                 |      | 6         |                 |      | 6         | pF            |

† All typical values are at  $V_{CC} = 2.5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ The bus-hold circuit can sink at least the minimum low sustaining current at  $V_{IL}$  max.  $I_{BHL}$  should be measured after lowering  $V_{IN}$  to GND and then raising it to  $V_{IL}$  max.

§ The bus-hold circuit can source at least the minimum high sustaining current at  $V_{IH}$  min.  $I_{BHH}$  should be measured after raising  $V_{IN}$  to  $V_{CC}$  and then lowering it to  $V_{IH}$  min.

¶ An external driver must source at least  $I_{BHLO}$  to switch this node from low to high.

# An external driver must sink at least  $I_{BHHO}$  to switch this node from high to low.

|| Current into an output in the high state when  $V_O > V_{CC}$

☆ High-impedance state during power up or power down

# SN54ALVTH162827, SN74ALVTH162827

## 2.5-V/3.3-V 20-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (unless otherwise noted)

| PARAMETER                           |                | TEST CONDITIONS                                                                                                                |                                                       | SN54ALVTH162827                  |      |      | SN74ALVTH162827      |      |     | UNIT |    |
|-------------------------------------|----------------|--------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------|----------------------------------|------|------|----------------------|------|-----|------|----|
|                                     |                |                                                                                                                                |                                                       | MIN                              | TYP† | MAX  | MIN                  | TYP† | MAX |      |    |
| V <sub>IK</sub>                     |                | V <sub>CC</sub> = 3 V, I <sub>I</sub> = −18 mA                                                                                 |                                                       | −1.2                             |      |      | −1.2                 |      |     | V    |    |
| V <sub>OH</sub>                     |                | V <sub>CC</sub> = 3 V to 3.6 V, I <sub>OH</sub> = −100 μA                                                                      |                                                       | V <sub>CC</sub> −0.2             |      |      | V <sub>CC</sub> −0.2 |      |     | V    |    |
|                                     |                | V <sub>CC</sub> = 3 V                                                                                                          |                                                       | I <sub>OH</sub> = −8 mA          |      |      |                      |      |     |      |    |
|                                     |                |                                                                                                                                |                                                       | I <sub>OH</sub> = −12 mA         |      |      | 2                    |      |     |      |    |
| V <sub>OL</sub>                     |                | V <sub>CC</sub> = 3 V to 3.6 V, I <sub>OL</sub> = 100 μA                                                                       |                                                       | 0.2                              |      |      | 0.2                  |      |     | V    |    |
|                                     |                | V <sub>CC</sub> = 3 V                                                                                                          |                                                       | I <sub>OL</sub> = 8 mA           |      |      | 0.8                  |      |     |      |    |
|                                     |                |                                                                                                                                |                                                       | I <sub>OL</sub> = 12 mA          |      |      | 0.8                  |      |     |      |    |
| I <sub>I</sub>                      | Control inputs | V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = V <sub>CC</sub> or GND                                                               |                                                       | ±1                               |      |      | ±1                   |      |     | μA   |    |
|                                     |                | V <sub>CC</sub> = 0 or 3.6 V, V <sub>I</sub> = 5.5 V                                                                           |                                                       | 10                               |      |      | 10                   |      |     |      |    |
|                                     | Data inputs    | V <sub>CC</sub> = 3.6 V                                                                                                        |                                                       | V <sub>I</sub> = 5.5 V           |      |      | 10                   |      |     |      |    |
|                                     |                |                                                                                                                                |                                                       | V <sub>I</sub> = V <sub>CC</sub> |      |      | 1                    |      |     |      |    |
|                                     |                |                                                                                                                                |                                                       | V <sub>I</sub> = 0               |      |      | −5                   |      |     |      |    |
| I <sub>off</sub>                    |                | V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> = 0 to 4.5 V                                                             |                                                       |                                  |      |      | ±100                 |      |     | μA   |    |
| I <sub>BHL</sub> <sup>‡</sup>       |                | V <sub>CC</sub> = 3 V, V <sub>I</sub> = 0.8 V                                                                                  |                                                       | 75                               |      |      | 75                   |      |     | μA   |    |
| I <sub>BHH</sub> <sup>§</sup>       |                | V <sub>CC</sub> = 3 V, V <sub>I</sub> = 2 V                                                                                    |                                                       | −75                              |      |      | −75                  |      |     | μA   |    |
| I <sub>BHLO</sub> <sup>¶</sup>      |                | V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = 0 to V <sub>CC</sub>                                                                 |                                                       | 500                              |      |      | 500                  |      |     | μA   |    |
| I <sub>BHHO</sub> <sup>#</sup>      |                | V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = 0 to V <sub>CC</sub>                                                                 |                                                       | −500                             |      |      | −500                 |      |     | μA   |    |
| I <sub>EX</sub> <sup>  </sup>       |                | V <sub>CC</sub> = 3 V, V <sub>O</sub> = 5.5 V                                                                                  |                                                       | 125                              |      |      | 125                  |      |     | μA   |    |
| I <sub>OZ(PU/PD)</sub> <sup>☆</sup> |                | V <sub>CC</sub> ≤ 1.2 V, V <sub>O</sub> = 0.5 V to V <sub>CC</sub> , V <sub>I</sub> = GND or V <sub>CC</sub> , OE = don't care |                                                       | ±100                             |      |      | ±100                 |      |     | μA   |    |
| I <sub>OZH</sub>                    |                | V <sub>CC</sub> = 3.6 V                                                                                                        | V <sub>O</sub> = 3 V, V <sub>I</sub> = 0.8 V or 2 V   | 5                                |      |      | 5                    |      |     | μA   |    |
| I <sub>OZL</sub>                    |                | V <sub>CC</sub> = 3.6 V                                                                                                        | V <sub>O</sub> = 0.5 V, V <sub>I</sub> = 0.8 V or 2 V | −5                               |      |      | −5                   |      |     | μA   |    |
| I <sub>CC</sub>                     |                | V <sub>CC</sub> = 3.6 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND                                           |                                                       | Outputs high                     |      | 0.07 | 0.1                  | 0.07 |     | 0.1  | mA |
|                                     |                |                                                                                                                                |                                                       | Outputs low                      |      | 3.2  | 5.5                  | 3.2  |     | 5.5  |    |
|                                     |                |                                                                                                                                |                                                       | Outputs disabled                 |      | 0.07 | 0.1                  | 0.07 |     | 0.1  |    |
| ΔI <sub>CC</sub> <sup>□</sup>       |                | V <sub>CC</sub> = 3 V to 3.6 V, One input at V <sub>CC</sub> − 0.6 V, Other inputs at V <sub>CC</sub> or GND                   |                                                       | 0.4                              |      |      | 0.4                  |      |     | mA   |    |
| C <sub>i</sub>                      |                | V <sub>CC</sub> = 3.3 V, V <sub>I</sub> = 3.3 V or 0                                                                           |                                                       | 3.5                              |      |      | 3.5                  |      |     | pF   |    |
| C <sub>o</sub>                      |                | V <sub>CC</sub> = 3.3 V, V <sub>O</sub> = 3.3 V or 0                                                                           |                                                       | 6                                |      |      | 6                    |      |     | pF   |    |

† All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ The bus-hold circuit can sink at least the minimum low sustaining current at  $V_{IL} \text{ max}$ .  $I_{BHL}$  should be measured after lowering  $V_{IN}$  to GND and then raising it to  $V_{IL} \text{ max}$ .

§ The bus-hold circuit can source at least the minimum high sustaining current at  $V_{IH} \text{ min}$ .  $I_{BHH}$  should be measured after raising  $V_{IN}$  to  $V_{CC}$  and then lowering it to  $V_{IH} \text{ min}$ .

¶ An external driver must source at least  $I_{BHLO}$  to switch this node from low to high.

# An external driver must sink at least  $I_{BHHO}$  to switch this node from high to low.

|| Current into an output in the high state when  $V_O > V_{CC}$

★ High-impedance state during power up or power down

□ This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

**SN54ALVTH162827, SN74ALVTH162827**  
**2.5-V/3.3-V 20-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

SCES079E – JULY 1996 – REVISED DECEMBER 1998

switching characteristics over recommended operating free-air temperature range,  $C_L = 30 \text{ pF}$ ,  $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | SN54ALVTH162827 |     | SN74ALVTH162827 |     | UNIT |
|-----------|-----------------|----------------|-----------------|-----|-----------------|-----|------|
|           |                 |                | MIN             | MAX | MIN             | MAX |      |
| $t_{PLH}$ | A               | Y              | 1.7             | 4.1 | 1.7             | 4.1 | ns   |
| $t_{PHL}$ |                 |                | 1.6             | 4   | 1.6             | 4   |      |
| $t_{PZH}$ | $\overline{OE}$ | Y              | 2.1             | 4.8 | 2.1             | 4.8 | ns   |
| $t_{PZL}$ |                 |                | 1.9             | 4.8 | 1.9             | 4.8 |      |
| $t_{PHZ}$ | $\overline{OE}$ | Y              | 2.4             | 6   | 2.4             | 6   | ns   |
| $t_{PLZ}$ |                 |                | 1.7             | 5   | 1.7             | 5   |      |

switching characteristics over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$ ,  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | SN54ALVTH162827 |     | SN74ALVTH162827 |     | UNIT |
|-----------|-----------------|----------------|-----------------|-----|-----------------|-----|------|
|           |                 |                | MIN             | MAX | MIN             | MAX |      |
| $t_{PLH}$ | A               | Y              | 1               | 3.9 | 1               | 3.9 | ns   |
| $t_{PHL}$ |                 |                | 1.5             | 3.7 | 1.5             | 3.7 |      |
| $t_{PZH}$ | $\overline{OE}$ | Y              | 1               | 5.6 | 1               | 5.6 | ns   |
| $t_{PZL}$ |                 |                | 1.7             | 4.1 | 1.7             | 4.1 |      |
| $t_{PHZ}$ | $\overline{OE}$ | Y              | 3.6             | 6.3 | 3.6             | 6.3 | ns   |
| $t_{PLZ}$ |                 |                | 1.7             | 5.1 | 1.7             | 5.1 |      |

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# SN54ALVTH162827, SN74ALVTH162827

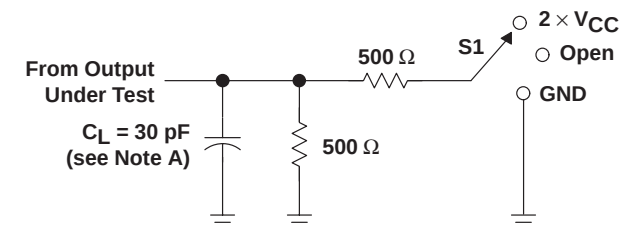
## 2.5-V/3.3-V 20-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

SCES079E – JULY 1996 – REVISED DECEMBER 1998

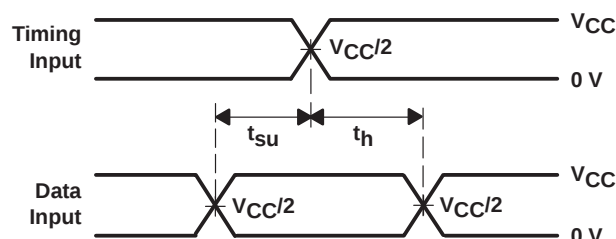
#### PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$

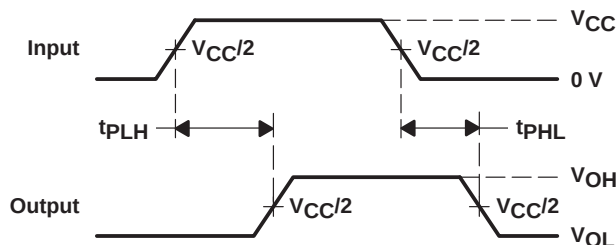


LOAD CIRCUIT

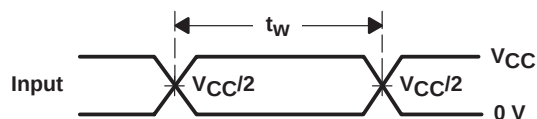
| TEST              | S1                |
|-------------------|-------------------|
| $t_{PLH}/t_{PHL}$ | Open              |
| $t_{PLZ}/t_{PZL}$ | 2 $\times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND               |



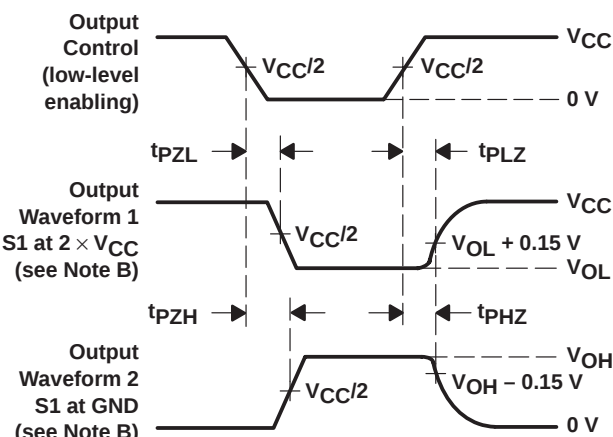
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



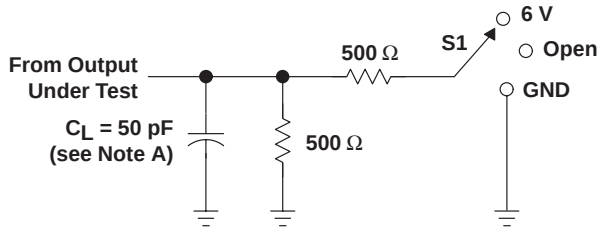
VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2 \text{ ns}$ ,  $t_f \leq 2 \text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

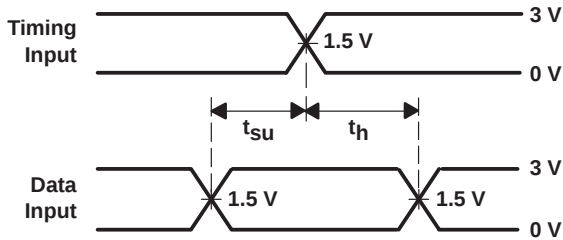
# PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$$

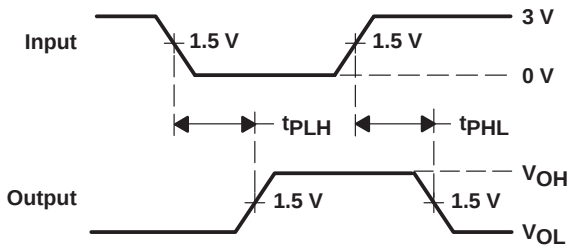


LOAD CIRCUIT

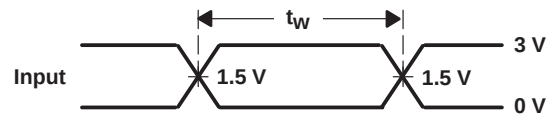
| TEST              | S1   |
|-------------------|------|
| $t_{PLH}/t_{PHL}$ | Open |
| $t_{PLZ}/t_{PZL}$ | 6 V  |
| $t_{PHZ}/t_{PZH}$ | GND  |



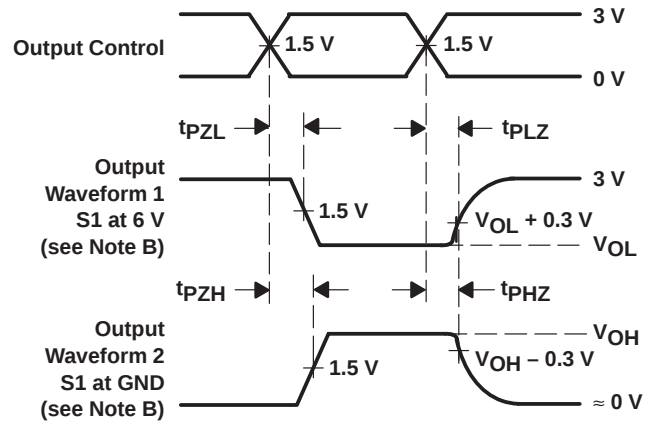
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
- D. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device  | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|-------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 74ALVTH162827DLG4 | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH162827GRE4 | ACTIVE                | TSSOP        | DGG             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH162827GRG4 | ACTIVE                | TSSOP        | DGG             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH162827LRG4 | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH162827VRE4 | ACTIVE                | TVSOP        | DGV             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH162827VRG4 | ACTIVE                | TVSOP        | DGV             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH162827DL | ACTIVE                | SSOP         | DL              | 56   | 20          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH162827GR | ACTIVE                | TSSOP        | DGG             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH162827LR | ACTIVE                | SSOP         | DL              | 56   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH162827VR | ACTIVE                | TVSOP        | DGV             | 56   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

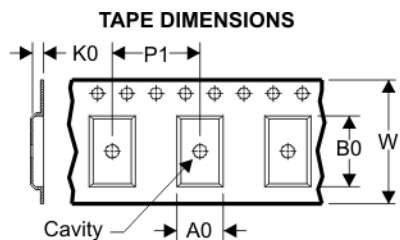
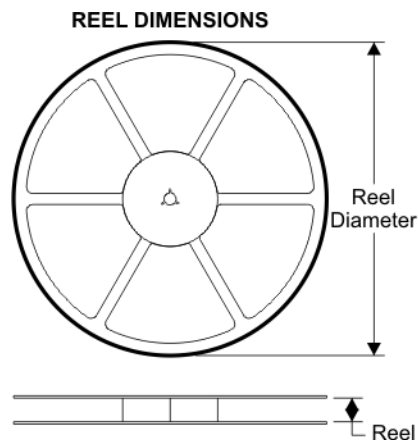
**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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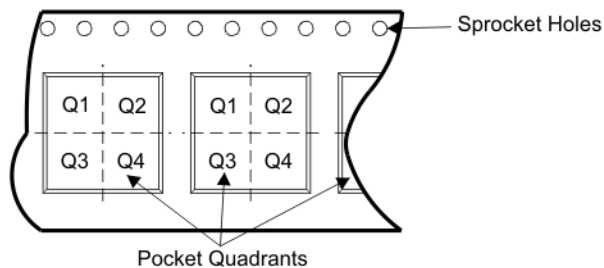
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**TAPE AND REEL BOX INFORMATION**



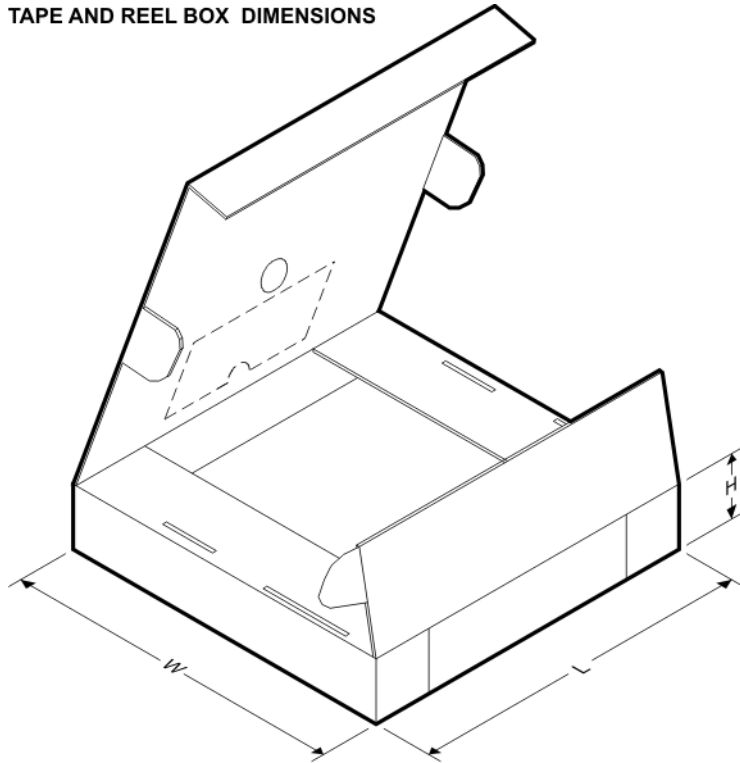
|    |                                                           |
|----|-----------------------------------------------------------|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



| Device            | Package | Pins | Site    | Reel Diameter (mm) | Reel Width (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|---------|------|---------|--------------------|-----------------|---------|---------|---------|---------|--------|---------------|
| SN74ALVTH162827GR | DGG     | 56   | SITE 41 | 330                | 24              | 8.6     | 15.6    | 1.8     | 12      | 24     | Q1            |
| SN74ALVTH162827LR | DL      | 56   | SITE 41 | 330                | 32              | 11.35   | 18.67   | 3.1     | 16      | 32     | Q1            |
| SN74ALVTH162827VR | DGV     | 56   | SITE 41 | 330                | 24              | 6.8     | 10.1    | 1.6     | 12      | 24     | Q1            |

## TAPE AND REEL BOX DIMENSIONS



| Device            | Package | Pins | Site    | Length (mm) | Width (mm) | Height (mm) |
|-------------------|---------|------|---------|-------------|------------|-------------|
| SN74ALVTH162827GR | DGG     | 56   | SITE 41 | 346.0       | 346.0      | 0.0         |
| SN74ALVTH162827LR | DL      | 56   | SITE 41 | 346.0       | 346.0      | 0.0         |
| SN74ALVTH162827VR | DGV     | 56   | SITE 41 | 346.0       | 346.0      | 0.0         |

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN

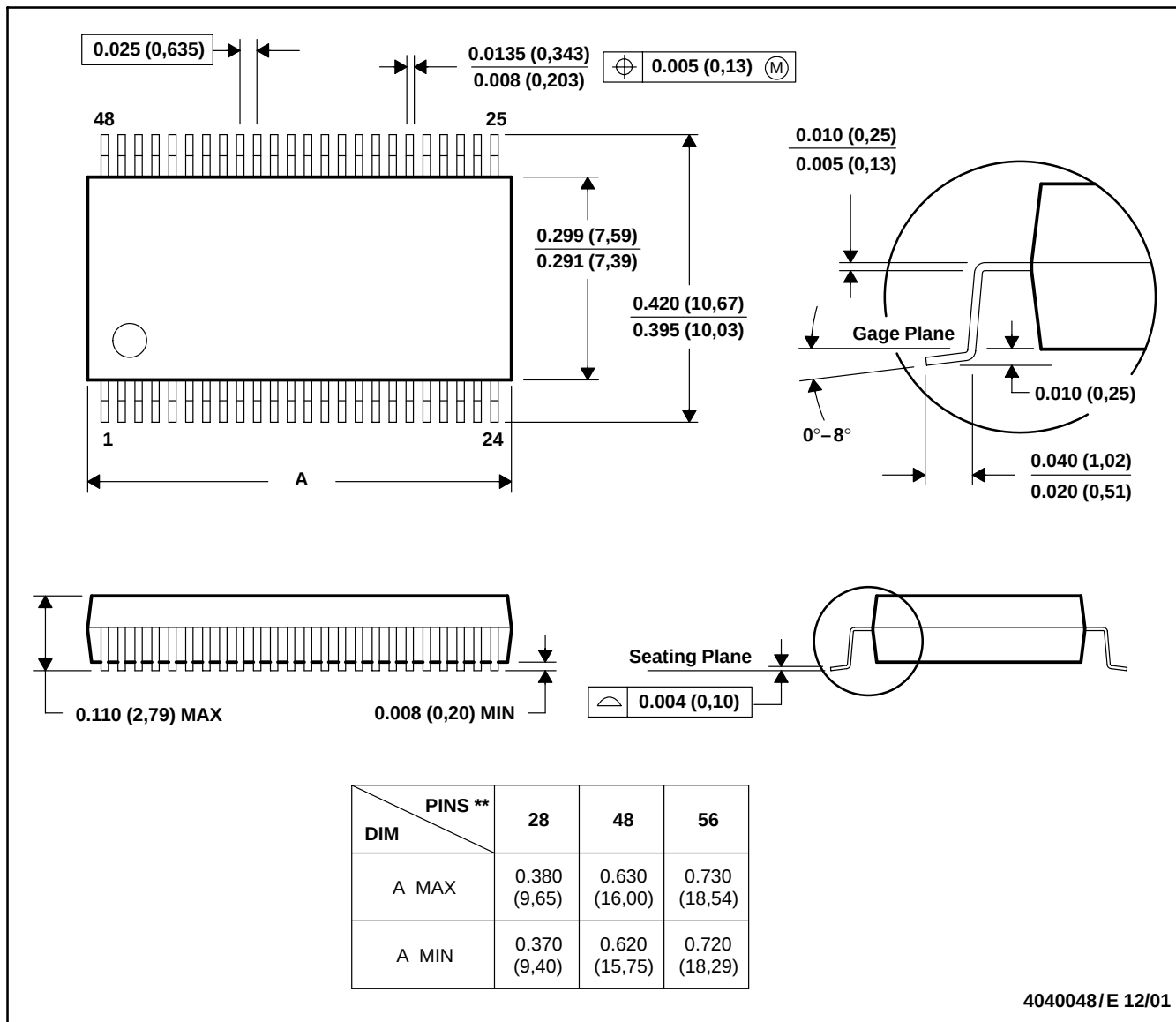


- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

DL (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MO-118

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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| DSP              | <a href="http://dsp.ti.com">dsp.ti.com</a>                         | Broadband          | <a href="http://www.ti.com/broadband">www.ti.com/broadband</a>           |
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